

Connectivity Chip Trends: Market Research Report

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Abstracts

The report analyzes and presents an overview of Connectivity Chips market worldwide. The report in addition provides global market estimates and projections for Wireless Connectivity ICs in US dollars for years 2012 through 2017. Supported with 7 market data tables, the report provides a review of global market trends, technological advancements, and competitive scenario. The report highlights on various strategic industry activities of major companies witnessed by the industry over the last few years. In addition, 42 companies operating in the Connectivity Chips arena worldwide including Broadcom Corporation, CSR PLC, INSIDE Secure, Marvell Technology Group Ltd., Qualcomm Atheros Inc., Samsung Semiconductor Inc., ST-Ericsson, Texas Instruments Inc., Toumaz Microsystems and others are profiled.

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Amazon. com to Take Over Mobile Processor Division of Texas Instruments

Samsung Acquires Handset Technology Development Division of CSR

Toumaz Establishes Toumaz Microsystems

Broadcom Takes Over NetLogic Microsystems

CSR Takes Over Zoran

Inside Secure Signs Agreement with Intel for NFC Technology

Qualcomm Acquires Atheros Communications

Texas Instruments Acquires National Semiconductor

3. PRODUCT LAUNCHES/INNOVATIONS

Apple to Introduce 802. 11ac Networking Capabilities in New Mac Models

Broadcom Launches New 5G WiFi Product Line

Broadcom Rolls Out BCM20732 Bluetooth Smart System-on-Chip

Dialog Semiconductor Introduces DA14580 SmartBond System-on-Chip

Broadcom Introduces BCM4752 Location Architecture

Marvell and Atheros Independently Introduce Wi-Fi Chips

ST-Ericsson Introduces Mobile Connectivity Chips

4. MARKET PARTICIPANTS

Analog Devices, Inc. (USA)

Aquantia Corporation (USA)

ASIX Electronics Corporation (Taiwan)

Atmel Corporation (USA)

Beken Corporation (China)

Broadcom Corporation (USA)

Cadence Design Systems, Inc. (USA)

Celero Communications (Israel)

CellGuide Ltd. (Israel)

CSR PLC (UK)

Dialog Semiconductor (Germany)

Freescale Semiconductor, Inc. (USA)
Fujitsu Ltd. (Japan)
Gainspan Corporation (USA)
GCT Semiconductor, Inc. (USA)
Glyn Ltd. (Australia)
INSIDE Secure (France)
Intel Corporation (USA)
Lantiq (Germany)
Marvell Technology Group Ltd. (Bermuda)
Maxim Integrated Products, Inc. (USA)
MediaTek, Inc. (Taiwan)
Microchip Technology, Inc. (USA)
Nordic Semiconductor ASA (Norway)
Nvidia Corporation (USA)
NXP Semiconductors NV (The Netherlands)
PMC-Sierra, Inc. (USA)
Qualcomm Atheros, Inc. (USA)
Quantenna Communications, Inc. (USA)
RDA Microelectronics (China)
Realtek Semiconductor Corporation (Taiwan)
Redpine Signals (USA)
Renesas Electronics Corporation (Japan)
RF Micro Devices, Inc. (USA)
Samsung Semiconductor, Inc. (USA)
Silicon Laboratories, Inc. (USA)
SkyTraq Technology, Inc. (Taiwan)
ST-Ericsson (Switzerland)
Telechips, Inc. (Korea)
Texas Instruments, Inc. (USA)
Toumaz Microsystems (UK)
u-blox AG (Switzerland)

5. APPENDIX

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